Tech Insights Hardware Anti-Tampering and Data Integrity Protection

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Global Presence



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- 1.5m+ reports
- 100k+ chips torn down
- 95k+ platform users
- 650+ companies served



We maintain the world's largest database of semiconductor and technology analysis.



Techniques

- Market Analysis
- IP Analysis
- Physical Analysis
- Functional Analysis
- Reverse Engineering











Who do you trust?

- Who do you trust?
- Satellite not trusting subscribers or owners of hardware.
- Casino does not trust players and/or staff. Regulators do not trust casino operators.
- Bank preventing fraud.



VideoCipherII - Early Anti-Tamper Example

 Cable and Satellite TV systems where among the first consumer devices requiring antitamper security.



Source: https://commons.wikimedia.org/wiki/File:General_Instruments_VideoCipher_II_2100E_satellite_descrambler.png

VideoCipherII – Mechanical Protection



 Security was provided by epoxy resin covering the ROM, RAM and CPU. The "Hack" was to expose the rom, replace with socket and manipulate keys from SRAM.

Casino Gaming Security

- Casino machines have features that protect the integrity of the accounting data called meters.
- Some scrambling is used along with canary values in SRAM.
- Programmable Logic Devices (PLDS) used to encode



Source: https://commons.wikimedia.org/wiki/File:Video_Poker_Machines.jpg

Video Poker Platform

- The early platform from the 1990s contained mostly off the shelf parts such as the Motorola 68000 with 27512 EEPROM devices.
- Critical Accounting Data was held in daughterboard using battery backup.



Security PAL

- The "Security PAL" on this machine generates the unique terminal ID and SRAM personalization data.
- Using the software access produced a type of cipher feedback transform.
- Programmable Array Logic



8294 Data Encryption Unit

- "Strong" cryptographic transformations were slow in software
- The 8294 Data Encryption processor was one of the earlier off the shelf encryption accelerators for DES cipher processing.



8294 Data Encryption Unit

- Bandwidth is a bit too low for real time in place memory enciphering.
- Good enough for your 300 baud modem.



The 56-bit key and 64-bit message data are transferred to and from the 8294 in 8-bit bytes by way of the system data bus. A DMA interface and three interrupt outputs are available to minimize software overhead associated with data transfer. Also, by using the DMA interface two or more DEU anay be operated in parallel to achieve effective system conversion rates which are virtually any multiple of 80 bytes/second. The 8294 also has a 7-bit TTL compatible output port for user-specified functions.

Because the 8294 implements the NBS encryption algorithm it can be used in a variety of Electronic Funds Transfer applications as well as other electronic banking and data handling applications where data must be encrypted.



Figure 1. Block Diagram

Figure 2. Pin Configuration

8-330 http://www.bitsavers.org/components/intel/_dataBooks/1981_Intel_Component_Data_Cataloa.pdf

Bank Machine and Pinpad

- Bank machines located in retailers requires a higher level of security than epoxy!
- Fake machine hardware could be engineered to capture banking secrets such as PIN and card numbers.
- Tapping that cable connection would be an obvious target.



Pinpad Anti-Tamper Seal

- PIN pad device contains an anti-tamper hologram seal.
- Who flips this over and verifies its presence prior to interaction?



Inside Early Generation Pin Pad





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DS5000 Series – 30 Years In Production! FULL DATA SHEET AVAILABLE --- CALL 214-450

LLAS SEMICONDUCTOR

DS5000 Soft Microcontroller

FEATURES PIN CONNECTIONS

DESCRIPTION

The DS5000 Soft Microcontroller is a high performance 8-bit CMOS microcontroller that offers "softness" in all aspects of its application. This is accomplished through the comprehensive use of nonvolatile technology to preserve all information in the absence of system V_{cc}. The entire program/data momory space is implemented using high speed, nonvolatile static CMOS RAM. Two memory size versions are available which offer either 8 Köytes or 32 Köytes of NV RAM for program/data stor-



	8-bit uC adapts to task-at-hand:	P1.0	1.000	40	Vcc
	- 8 or 32 Kbytes of high performance nonvolatile RAM	P1.1	2	39	PO.O ADO
	for program and/or data memory storage	P1.2	3	38	P0.1 AD1
	 Initial downloading of software in end system via on- 	P1.3	4	37	P0.2 AD2
	chip serial port	P1.4	5	36	P0.3 AD3
	- Capable of moolifying its own program and/or data	P1.5	6	35	P0.4 AD4
	129 internal populatile register for variable reten-	P1.6	7	34	P0.5 AD5
	tion	P1.7	8	33	P0.6 AD6
		RST	9	32	P0.7 AD7
•	Crashproof operation:	RXD P3.0	10	31	FAL AVOD
	- Maintains all nonvolatile resources for 10 years in the	TYD P3 1	111	30	ALE /DDOCS
	absence of V _{cc}	INTON D3 2	112	20	DECAN
	- Orchestrates orderly shutdown and automatic re-	INTO PJ.Z	12	29	PSEN
	Automatic restart on detection of errant software	TO DI A	1.1.1	20	P2.7 AID
	execution	T1 D1 5	14	2/	P2.0 A14
•	DAY BAYS IN COLORADO IN ALL DAY IN	WD 07.6	115	20	P2.5 A13
	Software Security Feature: Executes encrypted software to prevent unautho-	WR(P3.0	10	25	PZ.9 A12
		RULPS.7	110	27	P2.3 ATT
	rized disclosure	XIALZ VIALL	10	23	P2.2 ATU
	On-chip, full-duplex serial I/O ports	Vial	19	21	P2.1 A9
		VSS L	20	21	PZ.U AB
•	Two on-chip timer/event counters	40-Pin Encapsulated Package			
	32 parallel I/O lines	ORDERING INFORMATION			
•	Compatible with industry standard 8051 instruction set	DS5000 X	x-xx		
	and pinout			MAX. Clock	k Frequency
				08 8M	hz hz

08 8 Kbytes 32 32 Kbytes age. Furthermore, internal data registers and key con figuration registers are also nonvolatile.

A major benefit resulting from its nonvolatility is that the Soft Microcontroller allows program memory to be changed at any time, even after the device has been installed in the end system. Additionally, the size of the program and data memory areas in the embedded RAM is variable and can be set either when the application software is initially loaded or by the software itself during execution.

16 16MHz

Program/Data RAM

18

ource: https:/	/archive.org/	aetaiis)	/DallasSemiconductor-1992-
993ProductDo	taBookOCR/	nage/n	1203/mode/2up

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DS5000(T) Soft Microcontroller Module

www.maxim-ic.com

FEATURES 8-Bit 8051-Compatible Microcontroller Adapts to Task at Hand 8 or 32 kbytes of Nonvolatile RAM for Program and/or Data Memory Storage Initial Downloading of Software in End System via On-Chip Serial Port Capable of Modifying Its Own Program and/or Data Memory in End Use Crashproof Operation Maintains All Nonvolatile Resources for 10 Years in the Absence of V_{CC} at Room Temperature Power-Fail Reset Early Warning Power-Fail Interrupt Watchdog Timer Software Security Feature Executes Encrypted Software to Prevent Unauthorized Disclosure On-Chip, Full-Duplex Serial I/O Ports Two On-Chip Timer/Event Counters 32 Parallel I/O Lines

- Compatible with Industry Standard 8051 Instruction Set and Pinout
- **Optional Permanently Powered Real-Time** . Clock (DS5000T)

PIN ASSIGNMENT

			7.0 7.7		_	
P1.0		1	\bigcirc	40		Vcc
P1.1		2		39		P0.0 AD0
P1.2		3	DS5000(T)	38		P0.1 AD1
P1.3		4		37		P0.2 AD2
P1.4		5		36		P0.3 AD3
P1.5		6		35		P0.4 AD4
P1.6		7		34		P0.5 AD5
P1.7		8		33		P0.6 AD6
RST		9		32		P0.7 AD
RXD P3.0		10		31		ĒĀ
TXD P3.1		11		30		ALE
NT0 P3.2		12		29		PSEN
NT1 P3.3		13		28		P2.7 A15
T0 P3.4		14		27		P2.6 A14
T1P3.5		15		26		P2.5 A13
WR P3.6		16		25		P2.4 A12
RD P3.7		17		24		P2.3 A11
XTAL2		18		23		P2.2 A10
XTAL1		19		22		P2.1 A9
GND		20		21		P2.0 A8
	203					

40-Pin Encapsulated Package

Source: https://www.analog.com/media/en/technical-documentation/data-sheets/DS5000-DS5000T.pdf Pl

Secure your Reverse-Engineering



- Using the DS5000 device to secure my RE effort.
- Built and sold these devices to backup, edit and over-write SRAM modules



Printer Cartridge ASIC R.E.

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Printer Cartridge – Photo of Flex PCB



- Photographs of the device showing the contact points on the flex PCB.
- Contact points terminate at 8 pin device.



Communications Sniffing and Replay

Saleae Logic 1.2.10 – [Disconnected] – [open lid, remove 371 XL cyan, insert 371 XL cyan, close lid.logicdata] – [100 MHz Digital, 300 s]	Options 👻 🗕 🗖 🗙
Start Simulation +0.8 ms •0.1 ms +0.9 ms •0.1 ms	✓ Annotations
	A1 - A2 = 0.11972 ms A1 @ 4.9098346 s
	A2 @ 4.90995432 s
Q: Capture jopen lid, remo 🗘	Decoded Protocols
	Search indexing progress: 39% ///
Saleae Logic 1.2.10 - [Disconnected] - [open lid, remove 371 XL cyan, insert 371 XL cyan, close lid.logicdata] - [100 MHz Digital, 300 s]	Options * - 🗆 X
Start:Simulation 4 5 : 909 ms : 800 μs 4 5 : 909 ms : 800 μs 4 5 : 909 ms : 900 μs Start:Simulation +	Annotations +
	AI @ 4.9098346 s A2 @ 4.9098346 s
	▶ Analyzers
Q: Capture open lid, remo Q	Decoded Protocols
	Search indexing progress: 60%
Saleae Logic 1.2.10 - [Disconnected] - [open lid, remove 371 XL cyan, insert 371 XL cyan, close lid.logicdata] - [100 MHz Digital, 300 s]	Options 👻 😑 🗖 X
4 5 : 910 m 5 : 100 p 5 + 50 p	▼ Annotations +
	🖣 Timing Marker Pair 💌 🌣
	A1 @ 4.9098346 s A1 @ 4.9098346 s A2 @ 4.90995432 s
	► Analyzers
Q'' Capture open lid, remoQ	Decoded Protocols

 Three types of packets observed. Long command with payload, short command and response. Different Ink cartridges logged under various conditions.

X-Ray Image of Die and Bond Wires

 X-Ray image used to see bond wires and assigned pads.





Topside and Backside Poly Images



Process Sequence

Extract full chip netlist

30K Gates approx



Die Markings

 Die Markings indicate that all samples are the same die.





Netlist Generation and Visualization Tool





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Netlist Cluster

 Cells are organized in groups based on interconnect statistics using in house software tool.





Transformation Block





Active Shield Protection Block

 Red dots are the input/output connections to the gate cluster.





Mismatched Via Locations

- Despite identical die markings, it was found that the via positioning between metal layers was different.
- This was not significant as it did not affect the overall logic as they were found to connect address lines in different places.





Data Lines Connected to NV Memory Array

 This appears to be a great spot to probe, however reaching it at his position is not feasible though the layers. The lines must be traced to an area that resides under "null" space in each metal layer above it.



Data Bit Lines On M2 Layer

 Found a prospective spot on the M2 layer that can be reached from top though M5,4 and 3 layers.





Jet Etch - Entering the Package

 Jet Etching away a hole in the package exposing the die in the area of interest.



Jet Etch – Entering the Package





FIB Edit Planning



Delayer / Remove M5 Section





Delayer - Remove M3





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Pad Placement for Probes





Memory Read Out Setup





8 clocks to enter test mode 1 clock for a don't care 10 clocks per memory read * 64 reads = 640 clocks





Break Section

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